

L Number	Hits	Search Text	DB	Time stamp
1	7629	semiconductor and (cz or czochralski) and substrate	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/09/19 15:33
2	464	(semiconductor and (cz or czochralski) and substrate) and (roughen\$3 or grind\$3)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/09/19 15:34
3	244	((semiconductor and (cz or czochralski) and substrate) and (roughen\$3 or grind\$3)) and (impurity or dop\$3) and concentration	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/09/19 15:35